

MRD 11/6/00



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To the Honorable Commissioner of Patents

101519211

attached original documents or copy thereof.

1. Name of conveying party(ies):

Tutomu TAMURA
Hideki EGUCHI
Tomohide NAKAGAWA
Toshio HIRAMATSU
Manabu TAKEUCHI

Additional name(s) of conveying party(ies) attached? Yes No

2. Name and address of receiving party(ies):

Name: TOYO BOSEKI KABUSHIKI KAISHA

Internal Address: _____

Street Address: 2-8, Dojimahama 2-chome,
Kita-ku, Osaka-shi, Osaka-fu, Japan

City: _____ State: _____ ZIP: _____

Additional name(s) & address(es) attached? Yes No

3. Nature of conveyance:

- Assignment Merger
- Security Agreement Change of Name
- Other _____

Execution Date: October 20, 2000

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: _____

A. Patent Application No.(s)

09/672,807

B. Patent No.(s)

Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Edward W. Greason

Internal Address: _____

Street Address: Kenyon & Kenyon
One Broadway

City: New York State: N. Y. ZIP: 10004

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41):..... \$40.00

- Enclosed
- Authorized to be charged to deposit account

8. Deposit account number:

11-0600

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Edward W. Greason

Name of Person Signing

Signature

08/31/2000

Date

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ASSIGNMENT

WHEREAS, we, Tutomu TAMURA, Hideki EGUCHI,
Tomohide NAKAGAWA, Toshio HIRAMATSU and Manabu TAKEUCHI, citizens
of Japan, residing at c/o Toyo Boseki Kabushiki Kaisha,
Research Institute, 1-1, Katata 2-chome, Otsu-shi, Shiga-ken, Japan

~~respectively~~ have invented new and useful improvements in
INORGANIC REINFORCED POLYAMIDE RESIN COMPOSITIONS

for which we are about to make application for Letters Patent of
the United States, said application having been executed by us
on even date herewith; and

WHEREAS, Toyo Boseki Kabushiki Kaisha,
a Company of Japan, having its place of business at 2-8,
Dojimahama 2-chome, Kita-ku, Osaka-shi, Osaka-fu, Japan

(hereinafter referred to as the Assignee), is desirous of
acquiring the entire right, title and interest in and to the
application and the invention therein described and claimed and
any Letters Patent that may be issued upon the application or
for the improvements therein contained.

NOW, THEREFORE, for and in consideration of the
equivalent sum of One Dollar (\$1.00) to us in hand paid, the
receipt and sufficiency whereof is hereby acknowledged, we have
sold, assigned and transferred, and do hereby sell, assign and
transfer unto the Assignee, its successors and assigns, the
entire right, title and interest in and to the application and
the invention therein contained, including the right to apply
for any Letters Patent in the United States of America on the
invention, any Letters Patent that may issue thereon or
therefor, in the United States, and all reissues, extensions,
renewals, divisions and continuations thereof, to the full end
of the term or terms for which the Letters Patent may be issued,

the same to be held and enjoyed by the Assignee, its successors and assigns, the same as it would have been held and enjoyed by us if this Assignment and sale had not been made.

And we hereby authorize and request the Commissioner of Patents to issue all such Letters Patent to the Assignee, its successors and assigns, in accordance with this instrument of Assignment.

We hereby represent and warrant that there are no rights and interests outstanding inconsistent with the rights and interests granted herein and that we will not execute any instrument or grant or transfer any rights or interests inconsistent therewith, and we bind ourselves, our heirs, executors, administrators and legal representatives, as the case may be, to execute and deliver to the Assignee, its successors and assigns, any further documents or instruments and do any and all further acts that may be deemed necessary by the Assignee, its successors and assigns, to vest in the Assignee, its successors and assigns, the title herein conveyed, or intended so to be, and to enable such title to be recorded in the United States.

And we further covenant and agree, in consideration of the premises that we, our executors and administrators, will at any time upon request communicate to the Assignee, its successors and assigns, any facts relating to the invention and improvements and the history thereof, known to us or our executors and administrators, and that we will testify as to the same in any interference or other litigation when requested so to do by the Assignee, its successors and assigns.

IN TESTIMONY WHEREOF, I have hereunto set my hand and seal this 20th day of October, ~~1999~~2000.

TAMURA TUTOMU
(Name of Inventor) Tutomu TAMURA

IN TESTIMONY WHEREOF, I have hereunto set my hand and seal this 20th day of October, ~~1999~~2000.

Hideki Eguchi
(Name of Inventor) Hideki EGUCHI

IN TESTIMONY WHEREOF, I have hereunto set my hand and seal this 20th day of October, ~~1999~~ 2000.

Tomohide Nakagawa
(Name of Inventor) Tomohide NAKAGAWA

IN TESTIMONY WHEREOF, I have hereunto set my hand and seal this 20th day of October, ~~1999~~ 2000.

Toshio Hiramatsu
(Name of Inventor) Toshio HIRAMATSU

IN TESTIMONY WHEREOF, I have hereunto set my hand and seal this 20th day of October, ~~1999~~ 2000.

Manabu Takeuchi
(Name of Inventor) Manabu TAKEUCHI

WITNESSED BY:

Katsuhiko Nose
Katsuhiko NOSE

2-8, Dojimahama 2-chome, Kita-ku,
Osaka-shi, Osaka-fu, Japan
Address

WITNESSED BY:

Machiko Tanaka
Machiko TANAKA

2-8, Dojimahama 2-chome, Kita-ku,
Osaka-shi, Osaka-fu, Japan
Address

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